

C1812X224J5GAC

SMD Comm COG Flex, Ceramic, 0.22 uF, 5%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812



Click here for the 3D model.

Dimensions		
Chip Size	1812	
L	4.5mm +/-0.4mm	
W	3.2mm +/-0.3mm	
Т	1.6mm +/-0.20mm	
В	0.7mm +/-0.35mm	

Packaging Specifications	
Packaging	Bulk, Bag
Packaging Quantity	1

General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Component Weight	87 mg
Shelf Life	78 Weeks
MSL	1

Specifications			
Capacitance	0.22 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	5%		
Voltage DC	50 VDC		
Dielectric Withstanding Voltage	125 VDC		
Temperature Range	-55/+125°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms		
Dissipation Factor	0.1% 1 kHz 1.0Vrms		
Aging Rate	0% Loss/Decade Hour		
Insulation Resistance	4.5455 GOhms		

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